



# Product Change Notification

**Change Notification #:** 116217 - 00  
**Change Title:** **Boxed Intel® Core™ i7-8700K Processors  
 Boxed Intel® Core™ i7-8700 Processors  
 Boxed Intel® Core™ i5-8400 Processors  
 Boxed Intel® Core™ i5-8600K Processors  
 Boxed Intel® Core™ i5-8600 Processors  
 Boxed Intel® Core™ i5-8500 Processors ,  
 PCN 116217-00, Manufacturing Site, Label  
 Notification to Customers for Addition of  
 Factory Assembly/Test Site**  
**Date of Publication:** April 27, 2018

**Key Characteristics of the Change:**  
 Manufacturing Site, Label

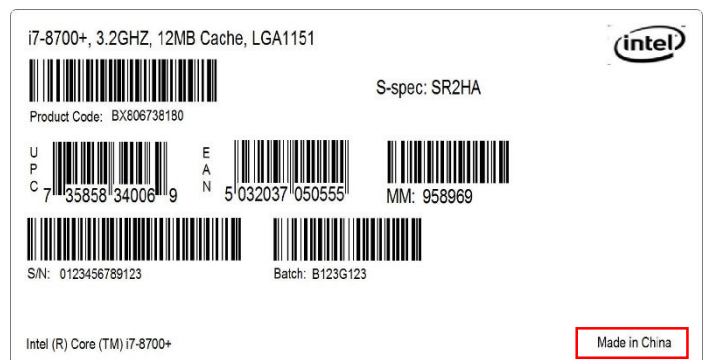
### Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	May 28, 2018
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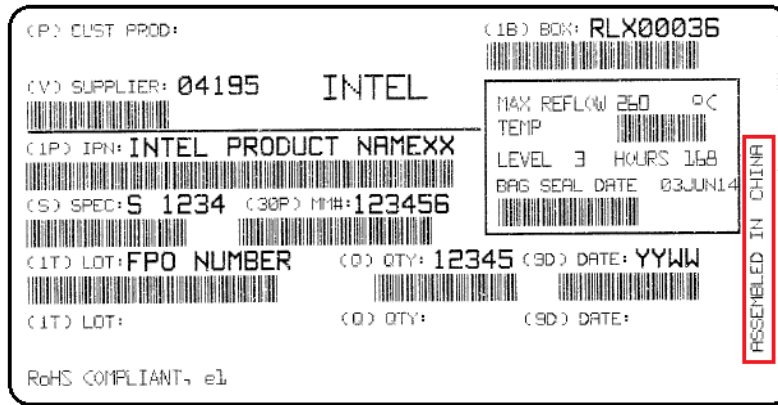
### Description of Change to the Customer:

In order to ensure a continuous supply of the Boxed Intel® Core™ Processors: i7-8700K, i7-8700, i5-8400, i5-8600K, i5-8600, i5-8500 listed in the "Products Affected" Table below, Intel will be adding an additional manufacturing site for Assembly/Test. The new site is located in China. The new manufacturing site has been certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

Due to this change, the "Made in Country" on the Box Label will now include China.  
 See label example below - This label is a representation for example purposes only. The actual label will reflect correct product data.



If the Country of Origin (COO) identification is marked on the product, this will now display MALAY or VIETNAM or CHINA. See generic label template).



### Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers for this change. Customers should notify their receiving department of the additional country which will be providing the Test/Finish on the products. It possible that Customers may receive a mix of material from both sites.

Customers may contact their Intel Field Sales Representative or the contacts listed on the last page of this Product Change Notification appropriate to your geo with questions.

Fabrication (Fab), sort, and assembly test facilities follow a Copy Exactly! (CE!) philosophy. Copy Exactly! enables delivery of product from multiple production sites, which operate as a virtual factory that performs consistently and independent of the manufacturing source site. Additional benefits include faster production ramps that improve product availability and improved consistency to quality performance.

Learn more about CE! at <http://www.intel.com/content/www/us/en/quality/exact-copy.html> web site.

### Products Affected / Intel Ordering Codes:

Marketing Name	Stepping	Product Code	S-Spec	MM#
Boxed Intel® Core™ i7-8700K Processor	U0	BX80684I78700K	S R3QR	961566
Boxed Intel® Core™ i7-8700 Processor	U0	BX80684I78700	S R3QS	961567
Boxed Intel® Core™ i5-8400 Processor	U0	BX80684I58400	S R3QT	961568
Boxed Intel® Core™ i5-8600K Processor	U0	BX80684I58600K	S R3QU	961570
Boxed Intel® Core™ i7-8700K Processor	U0	BXC80684I78700K	S R3QR	961573
Boxed Intel® Core™ i7-8700 Processor	U0	BXC80684I78700	S R3QS	961574
Boxed Intel® Core™ i5-8400 Processor	U0	BXC80684I58400	S R3QT	961575
Boxed Intel® Core™ i5-8600K Processor	U0	BXC80684I58600K	S R3QU	961576
Boxed Intel® Core™ i5-8600 Processor	U0	BX80684I58600	S R3X0	974956
Boxed Intel® Core™ i5-8500 Processor	U0	BX80684I58500	S R3XE	974957
Boxed Intel® Core™ i5-8600 Processor	U0	BXC80684I58600	S R3X0	975870
Boxed Intel® Core™ i5-8500 Processor	U0	BXC80684I58500	S R3XE	975871

### PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
April 27, 2018	00	Originally Published PCN



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## 116217 - 00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific/PRC Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

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